5-828214-0 - ACTIVE

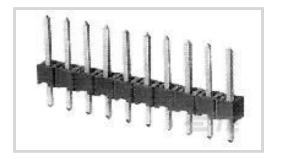
AMPMODU | AMPMODU Headers

TE Internal #: 5-828214-0 PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Breakaway, Tin, Through Hole - Solder, Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **50**

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Breakaway

Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
Configuration Features				
Connector Contact Load Condition	Fully Loaded			
PCB Mount Orientation	Vertical			
Number of Positions	50			
Number of Rows	1			
Board-to-Board Configuration	Parallel			
Electrical Characteristics				
Insulation Resistance	5000 MΩ			
Dielectric Withstanding Voltage (Max)	750 Vrms			
Body Features				
Primary Product Color	Green			
Contact Features				
Mating Square Post Dimension	.63 mm[.025 in]			

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PCB Contact Termination Area Plating Material Thickness	2 µm	
Contact Shape & Form	Square	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Phosphor Bronze	
Contact Mating Area Plating Material	Tin	
Contact Mating Area Plating Material Thickness	3 μm[118.11 μin]	
Contact Type	Pin	
Contact Current Rating (Max)	5 A	
Termination Features		
Square Termination Post & Tail Dimension	.63 mm[.025 in]	
Termination Post & Tail Length	3.2 mm[.126 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment	Without	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	PBT	
Dimensions		
PCB Thickness (Recommended)	1.4 mm[.055 in]	
Usage Conditions		
Housing Temperature Rating	Standard	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Circuit Application	Signal	
ndustry Standards		
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	250	

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Packaging Type **Product Compliance** For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU Compliant Compliant EU ELV Directive 2000/53/EC No Restricted Materials Above Threshold China RoHS 2 Directive MIIT Order No 32, 2016 Current ECHA Candidate List: JUNE 2023 EU REACH Regulation (EC) No. 1907/2006 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC Halogen Content Not Low Halogen - contains Br or Cl > 900 ppm. Solder Process Capability Not reviewed for solder process capability

Box

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



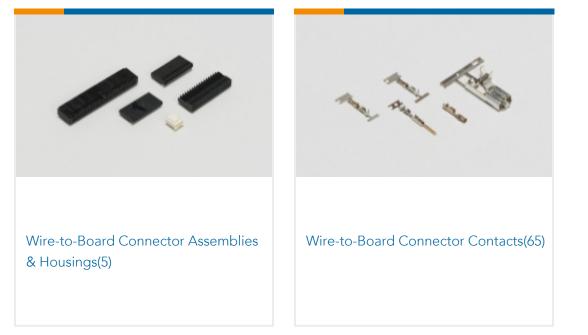
Also in the Series AMPMODU Headers

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16P STIFTWANNE 3MM	EMBOSS TAPE DDR3 204P 5.2H STD	MJ,R/A,LPF,6P/6C,SHLD,PNL,TRAY	6/6 PCB MOD.JACK SE
THE TE	₹TE	€ E TE	TE TE
TE Part #5223955-2 TE UPM Ver Receptacle 3P STD Power	TE Part #1676323-2 RN 0805 3K09 0.1% 10PPM 1KRL	TE Part #1676313-2 RN 0805 35K7 0.1% 10PPM 1KRL	TE Part #1676374-2 RN 0805 54K9 0.1% 10PPM 1KRL



Documents

PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Breakaway, Tin, Through Hole - Solder, Signal, AMPMODU Headers



Product Drawings 50P MOD2 STIFT LEI English **CAD** Files 3D PDF 3D Customer View Model ENG_CVM_CVM_5-828214-0_D.2d_dxf.zip English Customer View Model ENG_CVM_CVM_5-828214-0_D.3d_igs.zip English Customer View Model ENG_CVM_CVM_5-828214-0_D.3d_stp.zip English By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Agency Approvals

UL

English